

N And P-Channel Enhancement Mode MOSFET

Description

The HM4615Q uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

- ◆ N-channel:

$V_{DS} = 100V, ID = 8A$

$R_{DS(ON)} = 150m\Omega$ (typical) @ $VGS = 10V$

$R_{DS(ON)} = 160m\Omega$ (typical) @ $VGS = 4.5V$

- ◆ P-Channel:

$V_{DS} = -100V, ID = -6A$

$R_{DS(ON)} = 300m\Omega$ (typical) @ $VGS = -10V$

$R_{DS(ON)} = 330m\Omega$ (typical) @ $VGS = -4.5V$

- ◆ Excellent gate charge $\times R_{DS(ON)}$ product(FOM)

- ◆ Very low on-resistance $R_{DS(ON)}$

- ◆ 150 °C operating temperature

- ◆ Pb-free lead plating

- ◆ 100% UIS tested

100% UIS TESTED!

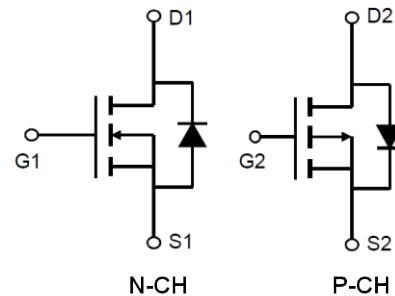
100% ΔVds TESTED!

Application

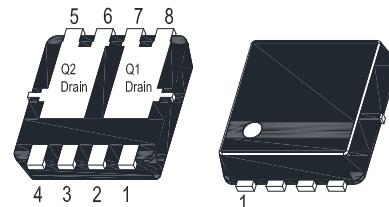
- ◆ Pch+Nch Complementary MOSFET for DC-FAN

- ◆ H-Bridge application

Schematic diagram



Marking and pin assignment



Q1:1.Source 2.Gate 7.Drain 8.Drain
 Q2:3.Source 4.Gate 5.Drain 6.Drain
 DFN3X3-8L Plastic Package

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
HM4615Q	-55°C to +150°C	DFN3X3-8L	5000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit		Unit
		N	P	
Drain-source voltage	V_{DS}	100	-100	V
Gate-source voltage	V_{GS}	± 20	± 20	V
Operating junction Temperature range	T_j	-55—150	-55—150	°C
Drain Current-Continuous (Silicon Limited)	I_D	18	-16	A
		5.6	-4.2	

Pulsed Drain Current (Package Limited)		I _{DM}	54	-48	A
Avalanche Current ^C		I _{AS} , I _{AR}	22	-27	A
Avalanche energy L=0.1mH ^C		E _{AS} , E _{AR}	24	36	mJ
Power Dissipation ^B	T _A =25°C	P _D	12	20	W
	T _A =75°C		5	8	
Junction and Storage Temperature Range		T _J , T _{STG}	-55—150		°C

N-Channel Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	100	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =100V, V _{GS} =0V	-	-	1	μA
Gate-body leakage	I _{GSS}	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
ON Characteristics						
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.3		2.5	V
Drain-source on-state resistance	R _{DS(ON)}	V _{GS} =10V, I _D =15A	-		150	mΩ
		V _{GS} =4.5V, I _D =15A	-		160	
Forward transconductance	g _{fs}	V _{DS} =5V, I _D =20A	-	43	-	S
Dynamic Characteristics						
Input capacitance	C _{ISS}	V _{DS} =15V, V _{GS} =0V f=1.0MHz	-	985	-	pF
Output capacitance	C _{OSS}		-	132	-	
Reverse transfer capacitance	C _{RSS}		-	114	-	
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, f=1.0MHz	-	1.6	2.4	Ω
Switching Characteristics						
Turn-on delay time	t _{D(ON)}	V _{DS} =15V V _{GS} =10V R _L =1.5Ω R _{GEN} =3Ω	-	4.4	-	ns
Rise time	t _r		-	9	-	
Turn-off delay time	t _{D(OFF)}		-	17	-	
Fall time	t _f		-	6	-	
Total gate charge	Q _g	V _{DS} =15V, I _D =15A V _{GS} =10V	-	19.9	-	nC
Gate-source charge	Q _{gs}		-	3.7	-	
Gate-drain charge	Q _{gd}		-	4	-	

Typical Performance Characteristics

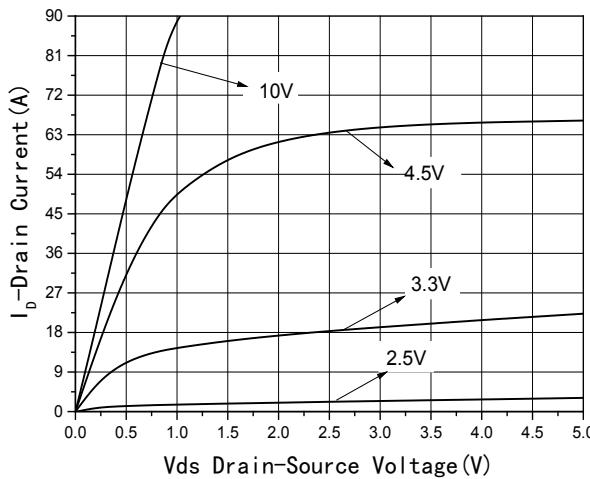


Fig1 Output Characteristics

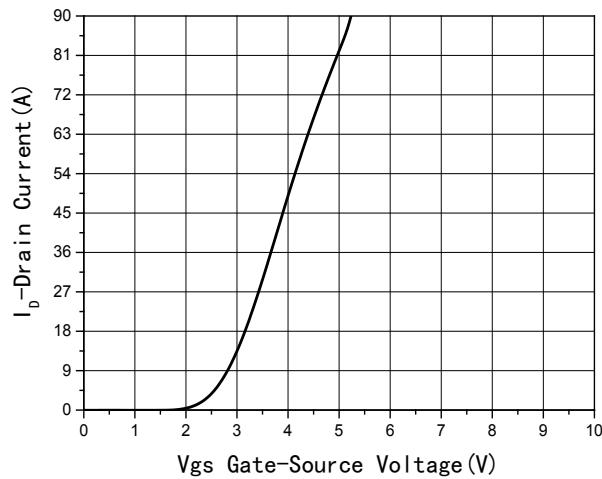


Fig2 Transfer Characteristics

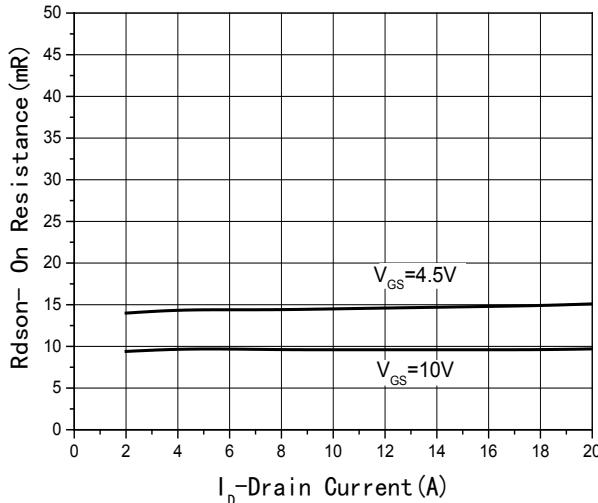


Fig3 Rdson-Drain current

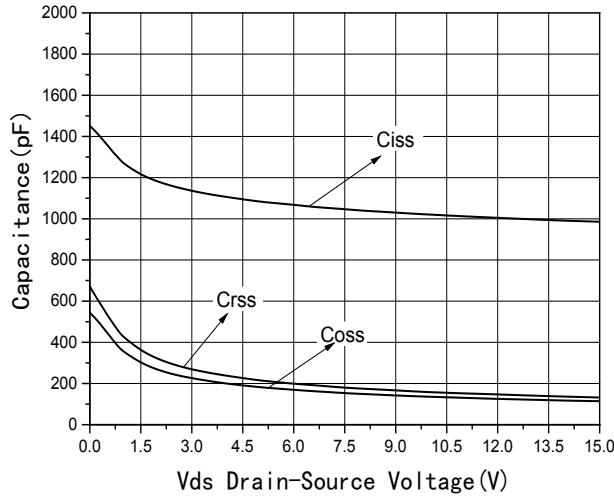


Fig4 Capacitance vs Vds

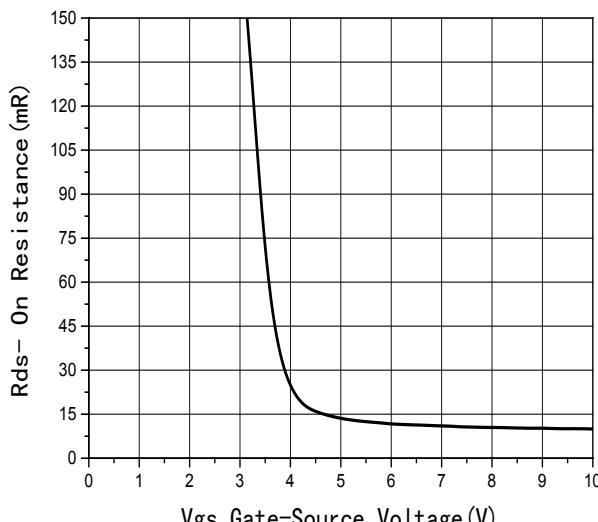


Fig5 Rdson-Gate Drain voltage

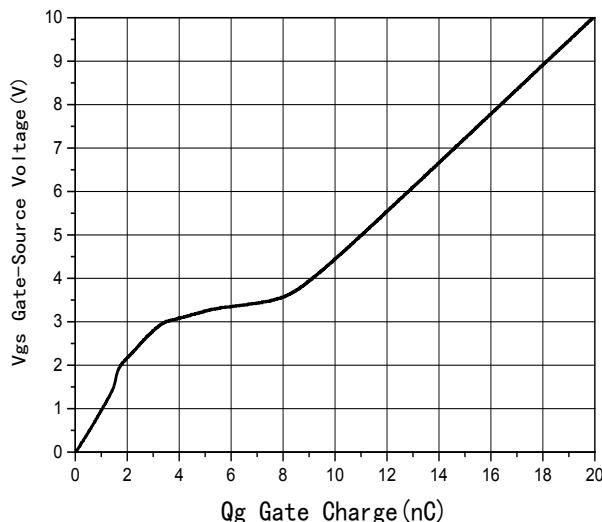


Fig6 Gate Charge

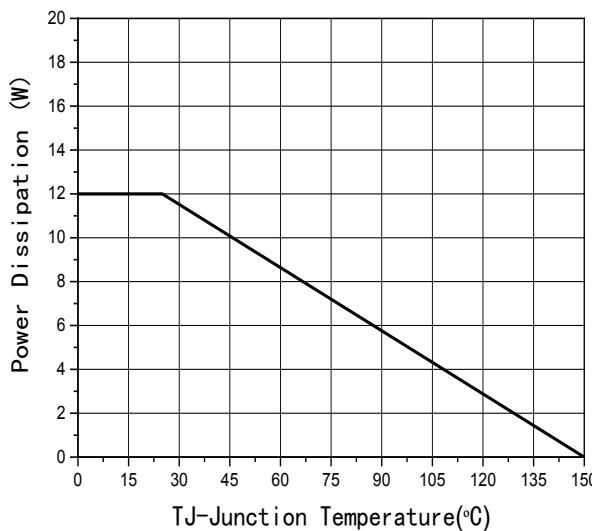


Fig7 Power De-rating

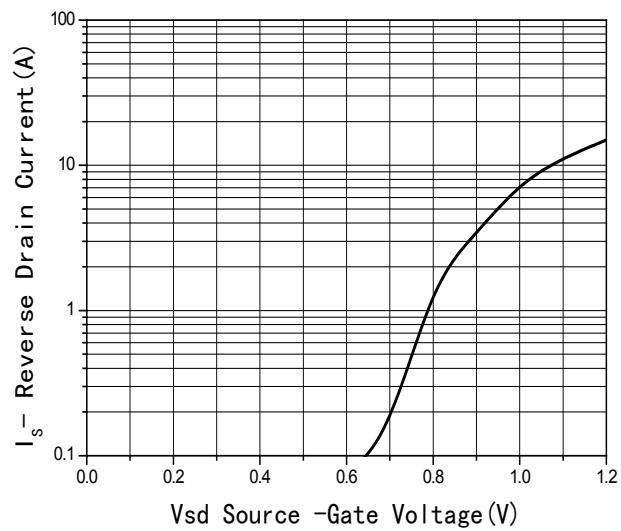


Fig8 Source-Drain Diode Forward

P-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$	-100	-	-	V
Zero gate voltage drain current	I_{DSS}	$\text{V}_{\text{DS}}=-100\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	-1	μA
Gate-body leakage	I_{GSS}	$\text{V}_{\text{DS}}=0\text{V}, \text{V}_{\text{GS}}=\pm20\text{V}$	-	-	±100	nA
ON Characteristics						
Gate threshold voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$	-1.2		-2.5	V
Drain-source on-state resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-20\text{A}$	-		300	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-20\text{A}$	-		330	
Forward transconductance	g_{fs}	$\text{V}_{\text{DS}}=-5\text{V}, \text{I}_D=-10\text{A}$	-	18	-	S
Dynamic Characteristics						
Input capacitance	C_{ISS}	$\text{V}_{\text{DS}}=-15\text{V}, \text{V}_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$	-	24	-	pF
Output capacitance	C_{OSS}		-	4.6	-	
Reverse transfer capacitance	C_{RSS}		-	4.2	-	
Gate resistance	R_{g}	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\text{V},$ $f=1.0\text{MHz}$	-	4	-	Ω
Switching Characteristics						
Turn-on delay time	$\text{t}_{\text{D(ON)}}$	$\text{V}_{\text{DS}}=-15\text{V}$ $\text{V}_{\text{GS}}=-10\text{V}$ $\text{R}_{\text{L}}=2.3\Omega$ $\text{R}_{\text{GEN}}=3\Omega$	-	10	-	ns
Rise time	tr		-	5.5	-	
Turn-off delay time	$\text{t}_{\text{D(OFF)}}$		-	3.6	-	
Fall time	tf		-	4.6	-	
Total gate charge	Q_{g}	$\text{V}_{\text{DS}}=-15\text{V}, \text{I}_D=-20\text{A}$ $\text{V}_{\text{GS}}=-10\text{V}$	-	1261	-	nC
Gate-source charge	Q_{gs}		-	152	-	
Gate-drain charge	Q_{gd}		-	137	-	

Typical Performance Characteristics

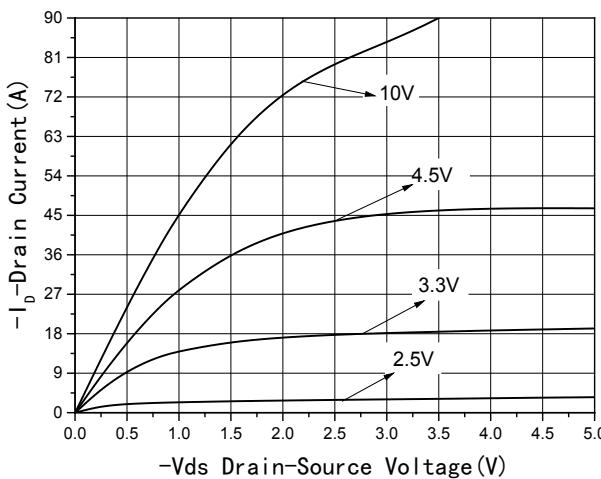


Fig1 Output Characteristics

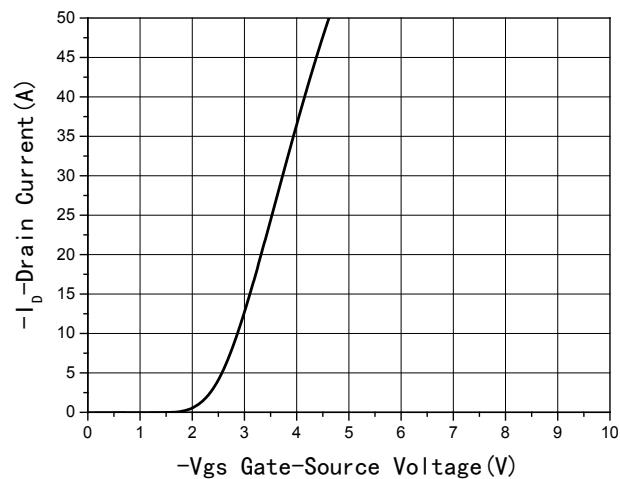


Fig2 Transfer Characteristics

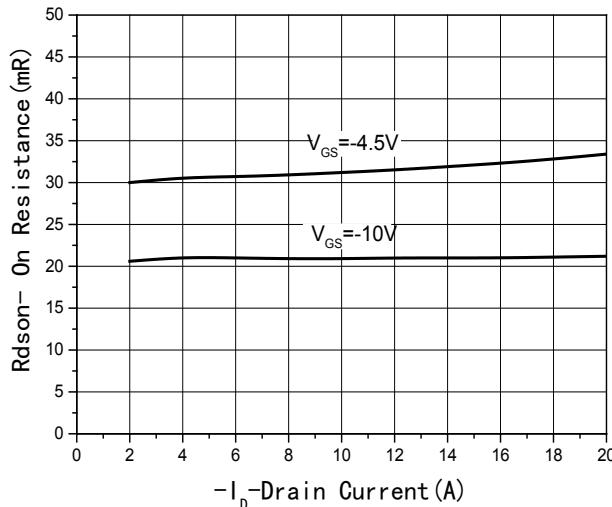


Fig3 Rdson-Drain current

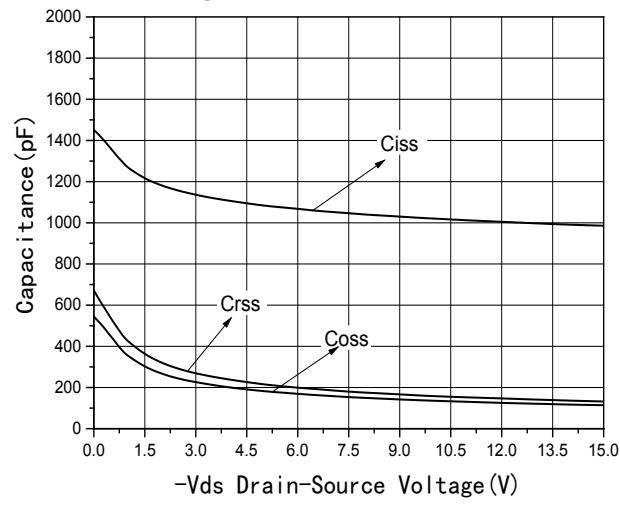


Fig4 Capacitance vs Vds

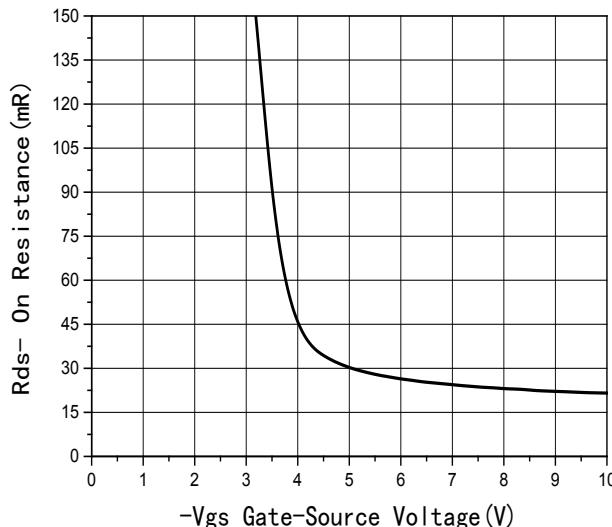


Fig5 Rdson-Gate Drain voltage

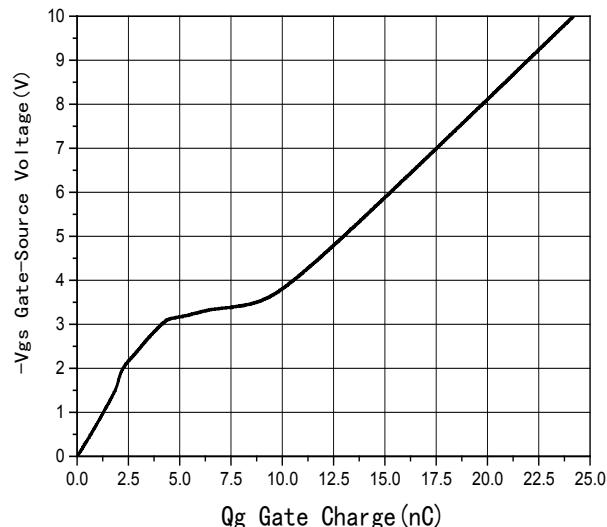


Fig6 Gate Charge

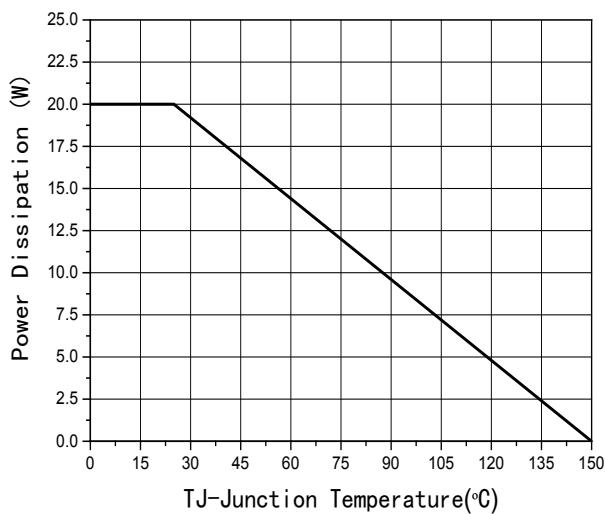


Fig7 Power De-rating

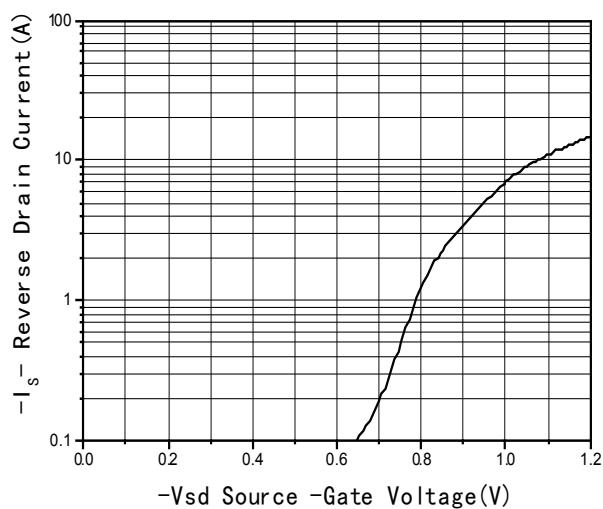
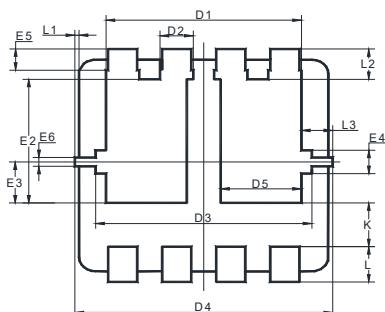
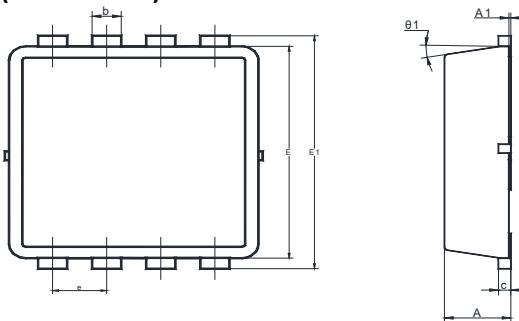


Fig8 Source-Drain Diode Forward

Package Outline Dimensions (Units: mm)

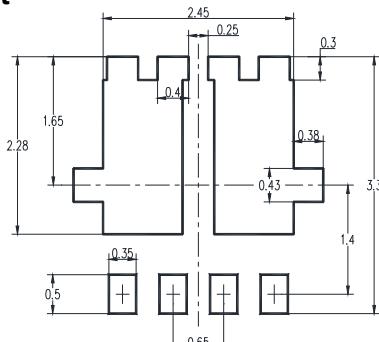
8 : B' L' !, @



UNIT	A	A1	b	c	D1	D2	D3	D4	D5	E	E1	E2	E3
mm	0.9	0.05	0.35	0.25	2.6	0.5	2.7	3.2	1.135	3.1	3.3	1.85	0.68
	0.7	0	0.24	0.1	2.4	0.3	2.5	3	0.935	2.9	3.1	1.65	0.48

UNIT	E4	E5	E6	e	K	L	L1	L2	L3	θ1
mm	0.43	0.4	0.25	0.7	0.72	0.5	0.1	0.53	0.475	12°
	0.23	0.2	0.15	0.6	0.52	0.3	0	0.33	0.275	0°

Recommended Soldering Footprint



Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
DFN3X3-8L	12	8 ± 0.1	0.315 ± 0.004	330	13	3,000